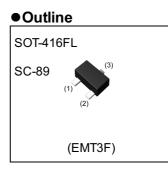


PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

## Datasheet

## AEC-Q101 Qualified

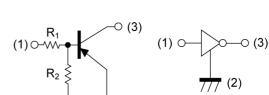
Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	4.7kΩ
R <sub>2</sub>	4.7kΩ



Inner circuit

## Features

- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 4.7 k\Omega$
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC143EEB HZG



·· (2)

(1) IN (BASE)
(2) GND (+) (EMITTER)
(3) OUT (COLLECTOR)

## Application

INVERTER, INTERFACE, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA143EEB HZG	SOT-416FL (EMT3F)	1616	TL	180	8	3000	13

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	-50	V
Input voltage	V <sub>IN</sub>	-30 to 10	V
Output current	Ι <sub>Ο</sub>	-100	mA
Collector current	I <sub>C(MAX)</sub> *1	-100	mA
Power dissipation	$P_D^{*2}$	150	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Cumhal	Conditions	Values			1.1	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Innutualtaga	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-	-	-0.5	V	
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -20mA	-3.0	-	-	V	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	-	-100	-300	mV	
Input current	I <sub>I</sub>	V <sub>I</sub> = -5V	-	-	-1.8	mA	
Output current	I <sub>O(off)</sub>	$V_{CC} = -50V, V_{I} = 0V$	-	-	-500	nA	
DC current gain	G <sub>I</sub>	V <sub>O</sub> = -5V, I <sub>O</sub> = -10mA	30	-	-	-	
Input resistance	R <sub>1</sub>	-	3.29	4.7	6.11	kΩ	
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz	

\*1 Characteristics of built-in transistor.

\*2 Each terminal mounted on a reference land.



## •Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

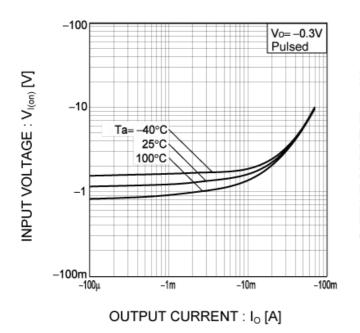


Fig.2 Output current vs. input voltage (OFF characteristics)

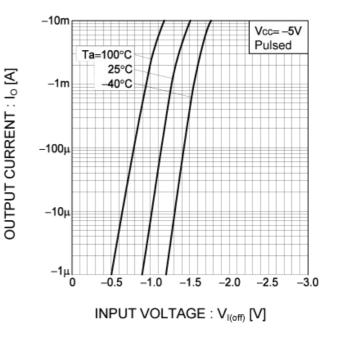


Fig.3 Output current vs. output voltage

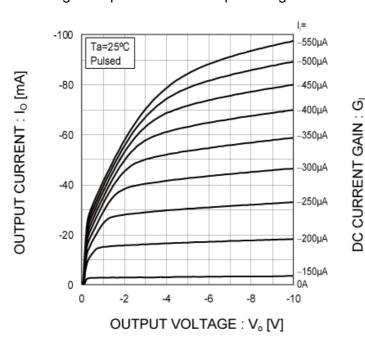
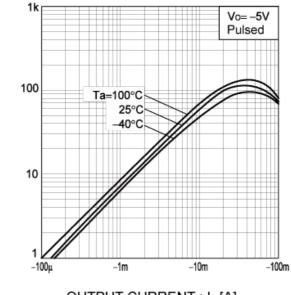
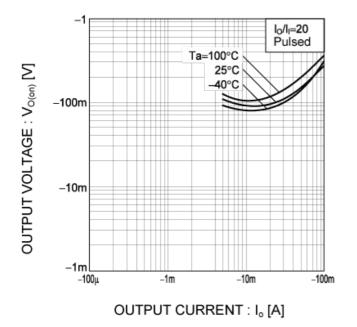


Fig.4 DC current gain vs. output current



OUTPUT CURRENT : I<sub>o</sub> [A]

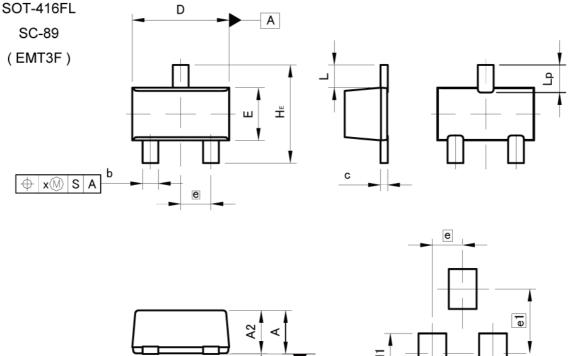
## •Electrical characteristic curves (T<sub>a</sub> =25°C)

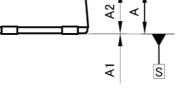


## Fig.5 Output voltage vs. output current



## Dimensions





Pattern of terminal position areas [Not a pattern of soldering pads]

b2

DIM	DIM MILIMETERS MIN MAX		INC	HES		
DIM			MIN	MAX		
A	0.65	0.85	0.026	0.033		
A1	0.00	0.10	0.000	0.004		
A2	0.60	0.80	0.024	0.031		
b	0.21	0.36	0.008	0.014		
С	0.08	0.18	0.003	0.007		
D	1.50	1.70	0.059	0.067		
E	0.76	0.96	0.030	0.038		
е	0.50		0.020			
HE	1.50	1.70	0.059	0.067		
L	0.3	0.37		15		
Lp	0.35	0.55	0.014	0.022		
x	—	0.10	_	0.004		
	· · · · ·					
DIM	MILIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
b2	-	0.46	-	0.018		
e1	—	1.05	—	0.041		
1	-	0.65	-	0.026		

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Application	ons
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JAPAN	USA	EU	CHINA
CLASSI	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASS III	CLASSⅢ	CLASSII

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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